

LINEAR TECHNOLOGY MATERIALS DECLARATION

ltc2995hud#trpbf

(Engineering Calculation)

QFN 3mm X 3mm Exp. Pad

(printed on: 2020-07-11 22:12:43)

TOTAL MASS (g) : 0.02312

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.000924	1000000	39965.8125		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.008752	975000	378550.625		
		Iron (Fe)	7439-89-6	0.000215	24000	9299.40429688		
		Phosphorus (P)	7723-14-0	0.000003	300	129.759140015		
		Zinc (Zn)	7440-66-6	0.000006	700	259.518280029		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.008976	1000000	388239.3125		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000413	1000000	17853.1777344		
		External Plating Total:				0.000413	1000000	17853.1777344
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000203	1000000	8780.3671875		
Internal Plating Total:				0.000203	1000000	8780.3671875		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000543	750000	23486.4023438		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000181	250000	7828.80078125		
Die Attach Total:				0.000724	1000000	31315.203125		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.001534	130000	66350.171875		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.010148	860000	438931.875		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000000	0	0		
		Carbon Black (C)	1333-86-4	0.000118	10000	5103.85888672		
		Encapsulation Total:				0.011800	1000000	510385.9375
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000080	1000000	3460.2434082		
					TOTAL MASS (g) :	0.02312		